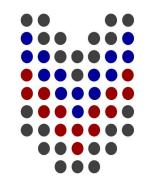


[ME 472]

Engineering Metrology & Quality Control



[CHAPTER 3] Advanced Measurement Methods



Assoc. Prof. Dr. A. Tolga BOZDANA

Mechanical Engineering Department
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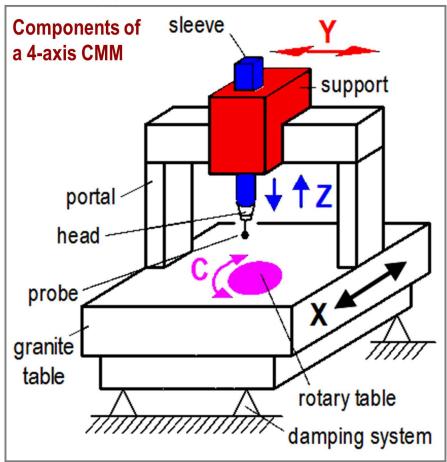


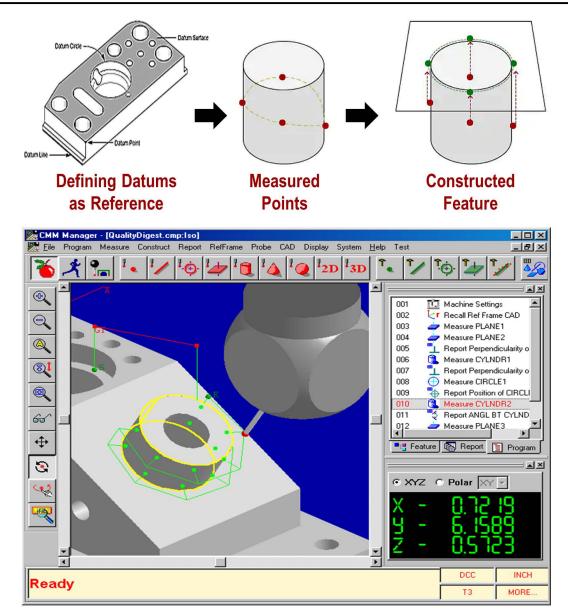




Coordinate Measuring Machine (CMM)

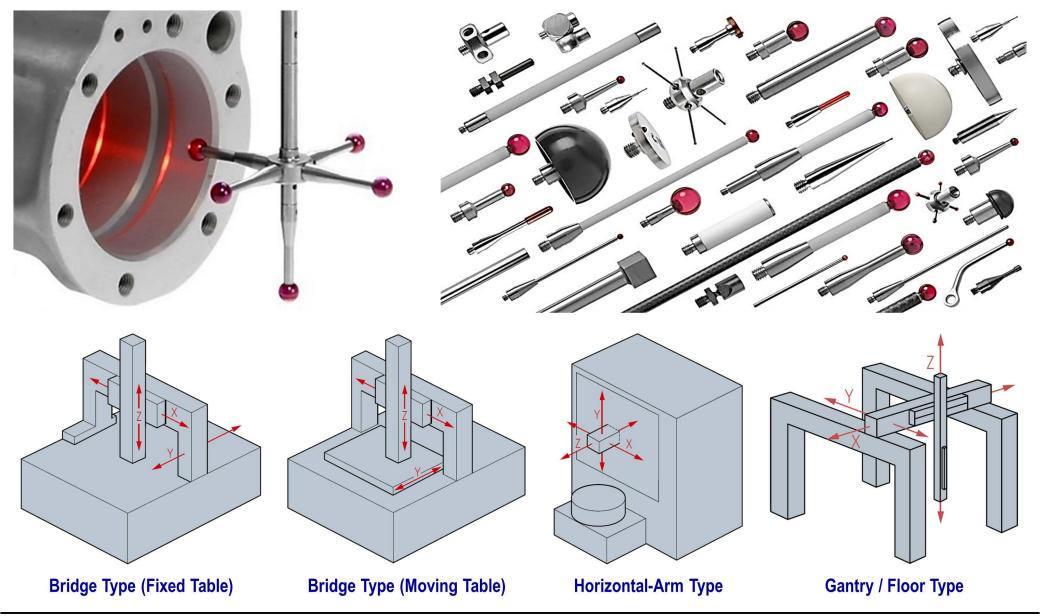
➤ Used for precise & accurate measurements of 3D coordinates of parts using small-head touching probes via movable axes.













RENISHAW Measurement Systems

(www.renishaw.com)



REVO-2 Dynamic Measuring Head (5-axis touch & scan probe system)



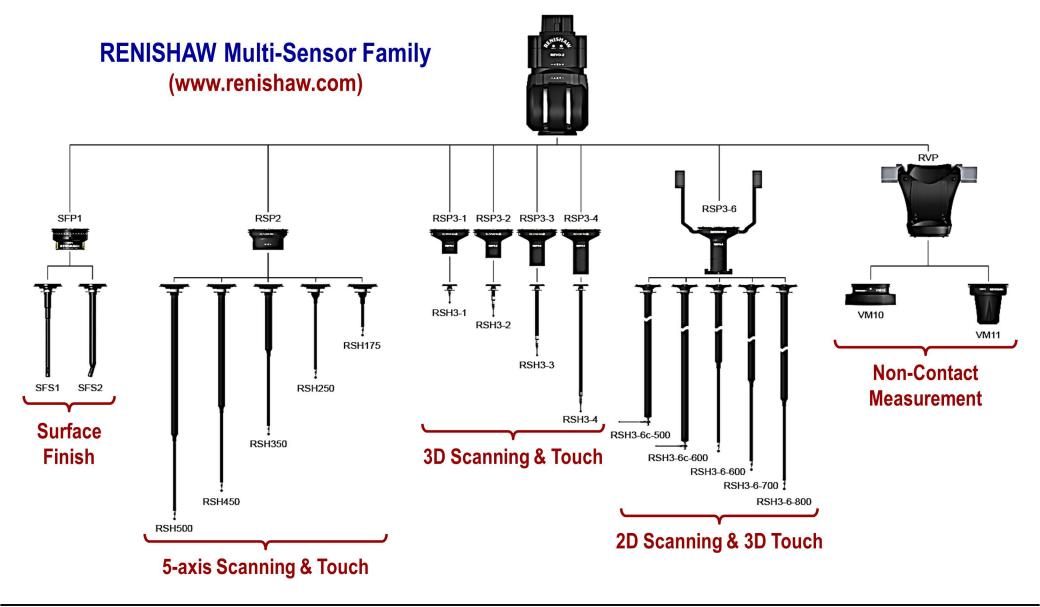
RVP Vision Probe (5-axis non-contact measurement)



RUP1 Ultrasonic Probe (Thickness measurement of 1-20 mm)











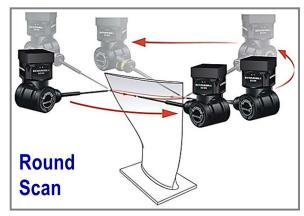








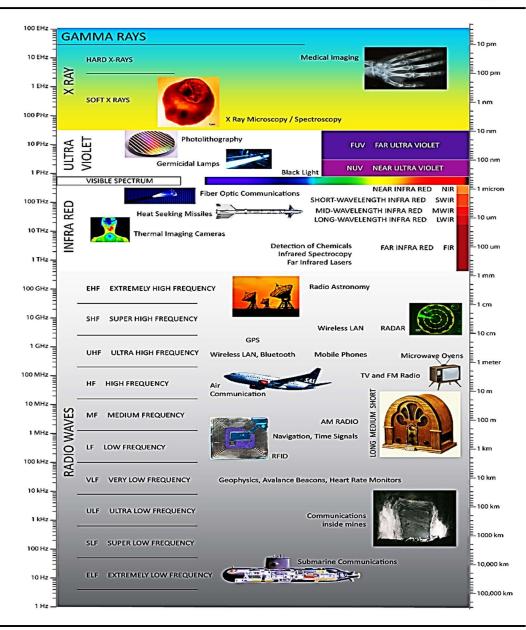






Measurement using Light

- ➤ ElectroMagnetic Radiation (EMR) consists of selfpropagating electromagnetic waves (such as light).
- ➤ EMR has **electrical & magnetic field components**, oscillating in phases that are perpendicular to each other and to the direction of propagation of wave.
- ➤ EMR behaves as particles (**photons**) having certain frequency & wavelength.
- ➤ ElectroMagnetic Spectrum (EMS) has the range of all electromagnetic frequencies.
- Frequencies are grouped by their use (such as radio waves, visible light, x-rays, microwaves, etc.)
- ➤ The chart shows EMS range with common uses for different parts of the spectrum. Frequency is shown on the left, wavelength is on the right.



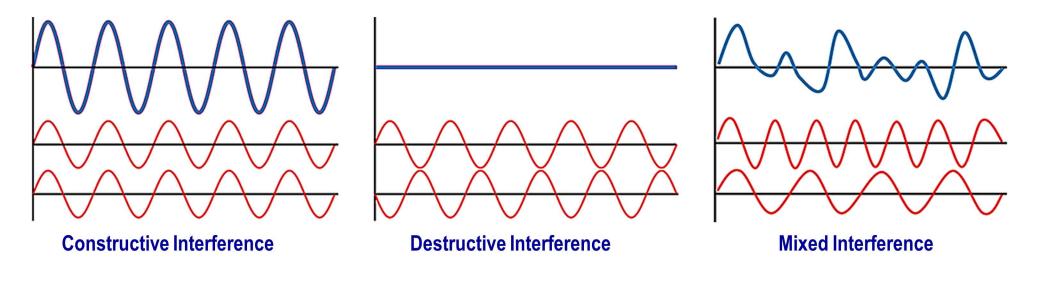


Interferometry

- The technique of superimposing (i.e. interfering) waves to detect differences between them.
- > Applied in variety of fields including astronomy, seismology, oceanography, optical metrology, quantum mechanics, and plasma physics.
- In metrology, it is used to determine shape and transmission properties of surfaces.

Interference of Waves

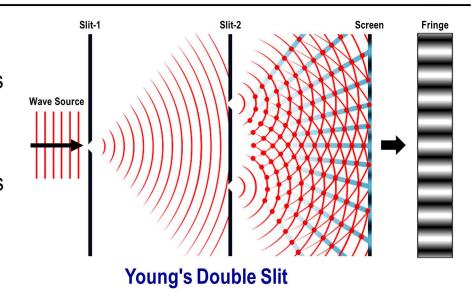
- ➤ Whenever two (or more) light waves come together at the same time and place, interference occurs.
- Constructive interference: The waves are in phase (i.e. their crests coincide), thus a single wave having higher crest (i.e. larger amplitude) is formed.
- > Destructive interference: Waves are out of phase (i.e. their crests are shifted), the amount of interference depends on amplitudes and frequencies of the waves.

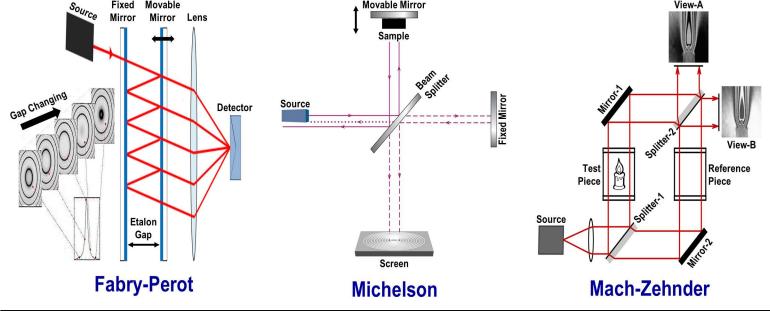


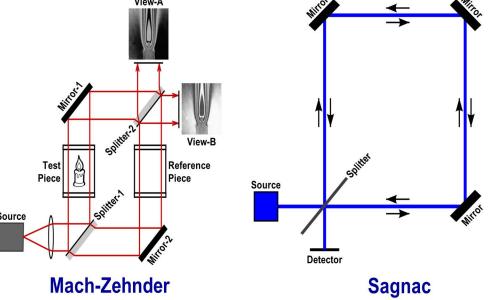


Classification of Interferometers

- ➤ Division of Wavefront: light beam is divided by passages (slits) through apertures that are placed side-by-side Llyod's Mirror, Young's Double Split, Fresnel's Biprism
- ➤ Division of Amplitude: light beam is divided by splitters (partially-reflecting plates) into beams of reduced amplitudes Michelson, Mach-Zehnder, Sagnac, Fabry-Perot, etc.



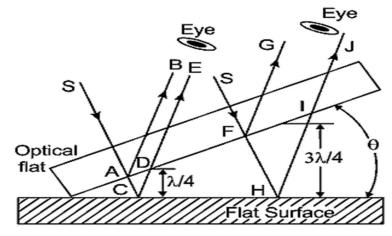








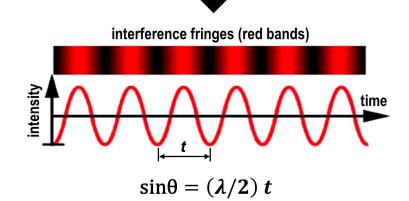
- The setup of interferometry includes a monochromatic light source and an optical flat (a disc of stress-free glass or quartz with highly polished two plane faces flat and parallel).
- \triangleright The optical flat is placed on the part surface with small angle (θ), the light beam from source (S) is projected onto the optical flat, and the reflected light beams are seen at eye.
- > At point A, the light ray is partially reflected to the eye (along AB) and partially transmitted & reflected to the eye (along CDE).
- > Thus, two reflected components are collected & recombined by the eye (the lengths of travelled paths differ by the amount ACD).
- > When the lengths of consecutive reflections (CDE & HIJ) differ by the amount of **half-wavelength** (i.e. $\lambda/2$, which is the wavelength of original light ray from source), then the surface perfectly flat.
- > Therefore, the part surface will be seen as pattern of dark bands (fringes), which are straight for the case of a flat surface.



$$AC = DC = \frac{\lambda}{4}$$

$$FH = HI = 3\frac{\lambda}{4}$$

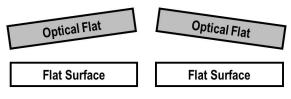
$$AC - FH = \frac{\lambda}{2}$$

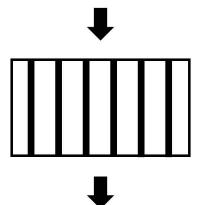






- Indicates perfectly flat surface.
- \triangleright Assume: $\lambda = 0.6328 \,\mu\text{m}$
- \triangleright Then: flatness = 0.3164 µm

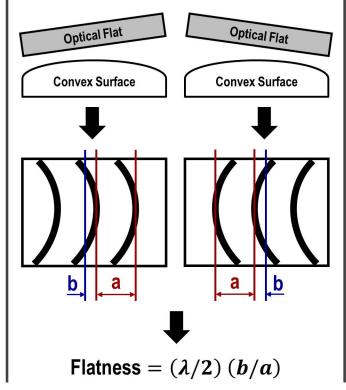




Flatness = $(\lambda/2)$

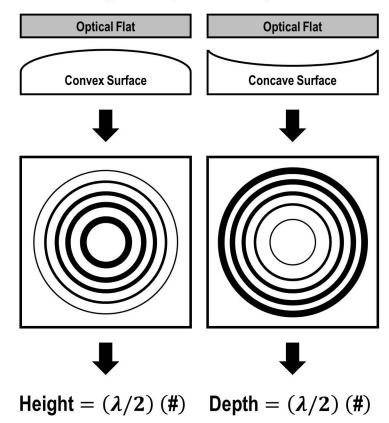
Fringe Analysis: Curved Pattern

- Indicates convex / concave surface.
- > Red lines drawn tangent to center of two adjacent fringes. Blue line drawn by the centroid of a single fringe.
- \triangleright Assume: **a** = 5.02 μ m & **b** = 1.24 μ m
- \triangleright Then: flatness = 0.078 μ m



Fringe Analysis: Circular Pattern

- > Indicates convex or concave surface.
- The total distance between peak & valley (i.e. **height or depth of surface**) is calculated.
- ➤ Assume: no. of fringes (full circles) = 5
- ➤ Then: height or depth = 1.582 µm



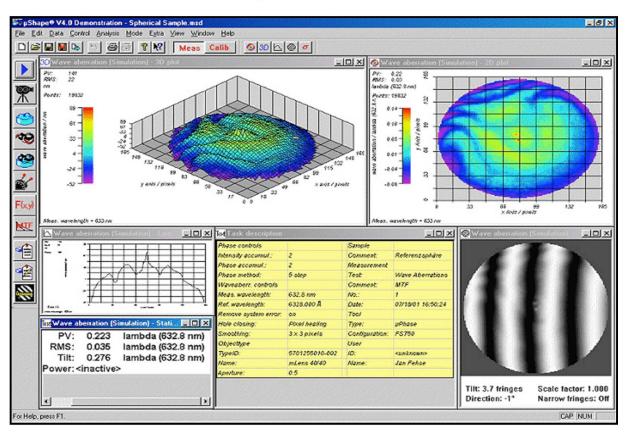


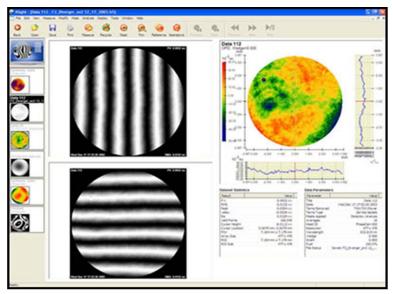


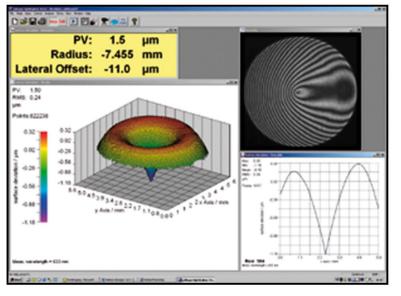


Fringe Analysis Software

- > Special-purpose software are required for accurate & precise analysis of complex fringe patterns.
- > They are used for analysis of surface topography to determine flatness, waviness, roughness, etc.





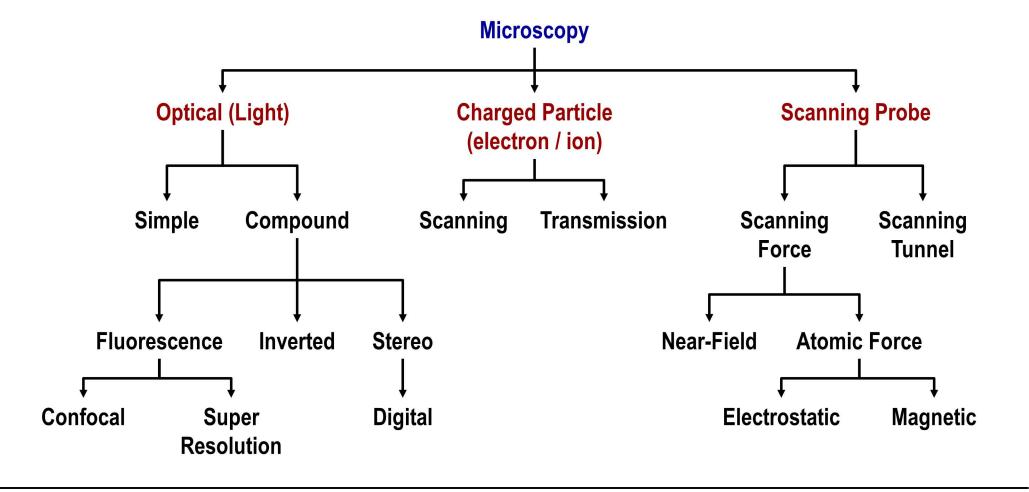






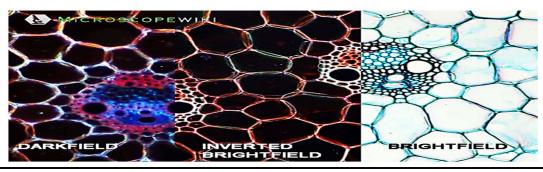
Microscopy

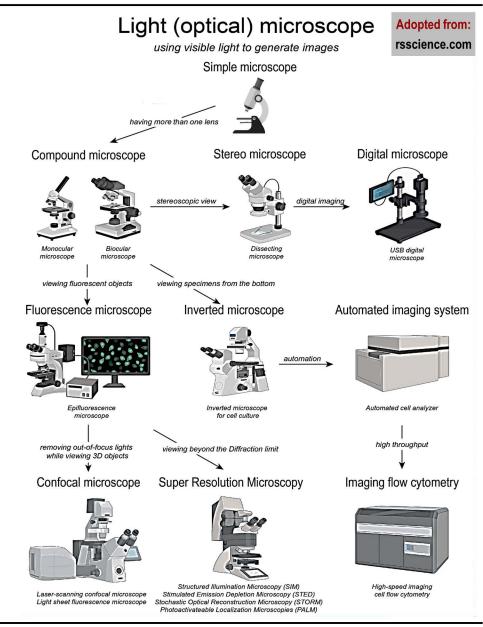
- > The technical field of using microscopes to view desired portion of objects that cannot be seen with naked eye.
- Classified depending upon working principle, image resolution & precision, feature detection, and so on.



Optical (Light) Microscopy

- ➤ Use of visible light transmitted through or reflected from the object via lens (or multiple lenses) for magnified view.
- Classification according to lens:
 - ➤ Simple: a single lens
 - ➤ Compound: multiple lenses
- Classification according to eyepiece:
 - ➤ Monocular: look through single eyepiece
 - ➤ Binocular: look through two eyepieces
 - ➤ Trinocular: binocular head plus third ocular (possible installation of a camera)
- Classification according to background lightening:
 - ➤ Bright Field: dark image against bright background
 - ➤ Dark Field: bright image against dark background

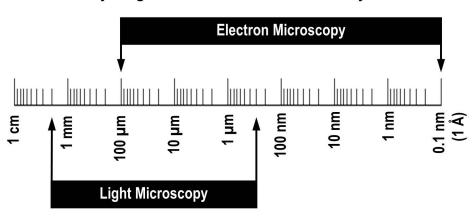


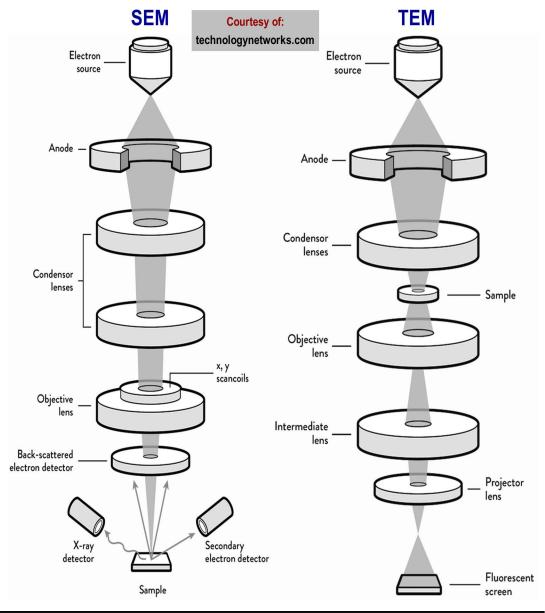




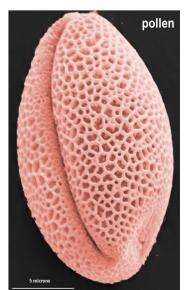
Electron Microscopy

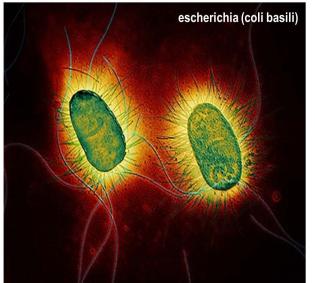
- ➤ Sample is **bombarded by accelerating the beam of electrons**, and the details of sample's surface and/or internal characteristics are revealed.
- Much higher resolutions than light microscopy with visualization of spots down to 0.1 nm (1Å).
- > Two common types:
 - ➤ Scanning Electron Microscopy (SEM): visualizing the surface characteristics of objects
 - ➤ Transmission Electron Microscopy (TEM): analyzing the inner structure of objects

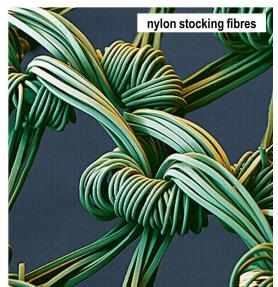


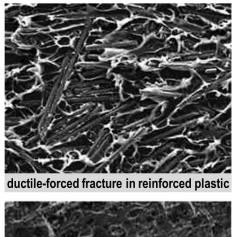


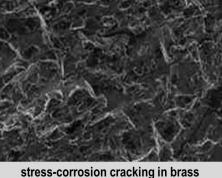




















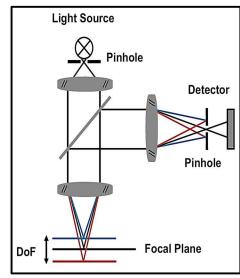




3D Microscopy: Confocal Microscopes

- > The cure for problem of **Depth of Field (DoF)** in classical microscopy so that providing **higher vertical resolution**.
- > This is accomplished by means of a modified optical path.
- Recently, the laser has been used as light source in Laser Scanning Confocal Microscope (LSCM).

Photo: Olympus LEXT OLS5000 (www.olympus-ims.com/en/metrology/ols5000)

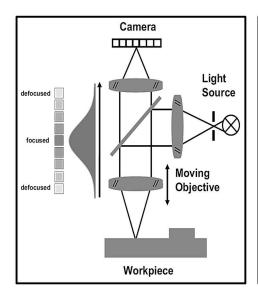




3D Microscopy: Variable-Depth Focal Microscopes

- > Focal Depth Variation (FDV) achived by vertical scanning of the surface with Through-Focus Scanning Optical Microscope (TSOM).
- > This is accomplished using highly sophisticated software to calculate the best focus from continuously recorded data, which enables reconstruction of **3D surface topography**.

Photo: Alicona InfiniteFocus (www.alicona.com/en/products/infinitefocus)





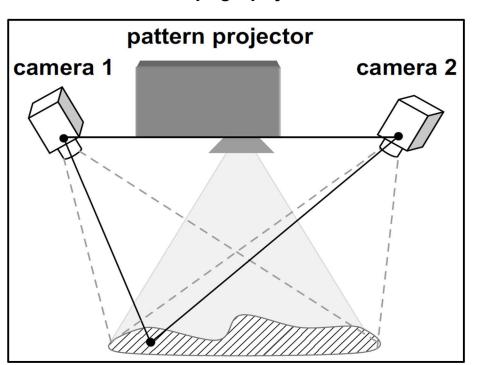


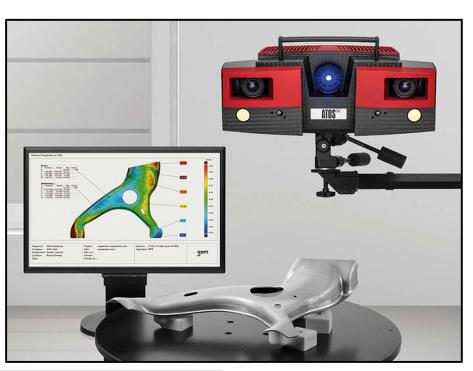




3D Scanning Systems

- Used for 3D fringe projection of complex surfaces (particularly free-form surfaces).
- Consist of two digital cameras and a pattern (fringe) projector enclosed at a fixed angle.
- Light waves with shifted patterns of parallel sinusoidal stripes are projected onto the surface. If the surface is not plane flat, then the patterns get distorted. Both cameras record an image of the distorted fringe pattern, and hence the surface topography could be constructed.





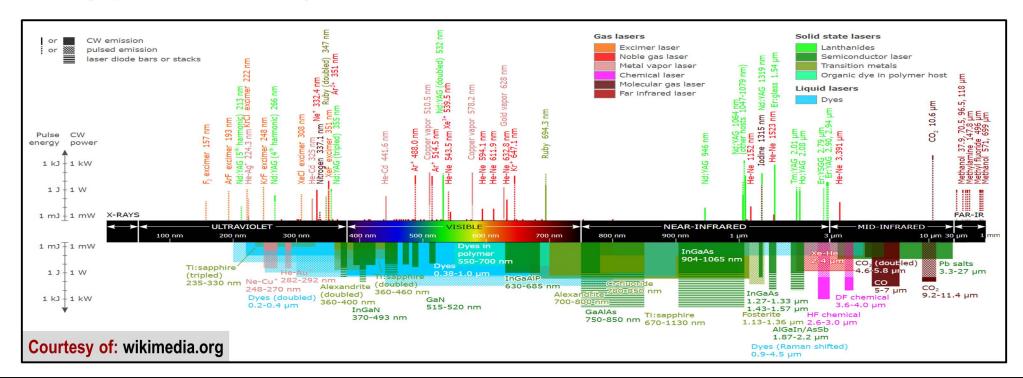
More information: www.gom.com/metrology-systems/atos.html





Measurement using Laser

- LASER is an acronym for "Light Amplification by Stimulated Emission of Radiation"
- It is a device that emits light (electromagnetic radiation) through a process of optical amplification based on the stimulated emission of photons.
- > Different types of laser are used for research and industrial purposes (metal cutting, welding, dynamic alignment/positioning, dimensional measurements, nondestructive testing, lithography, medical treatments, military applications, and so on).



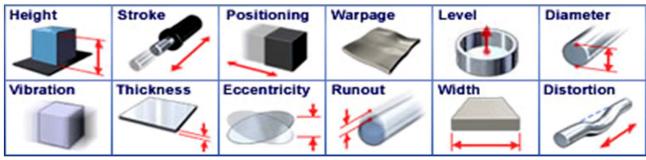


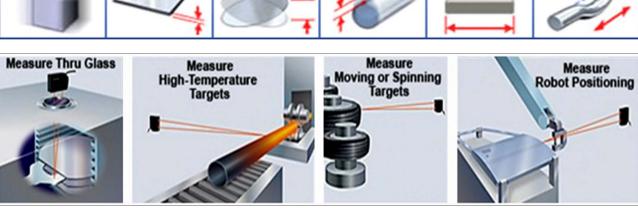


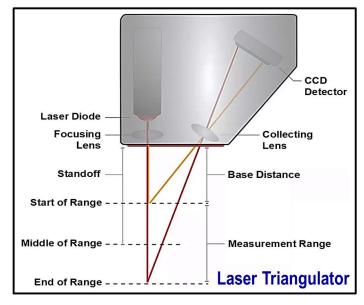


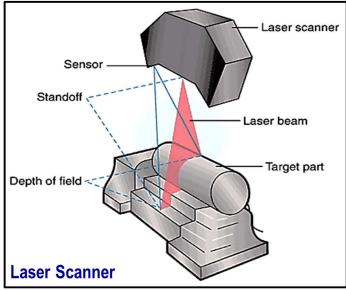
- Laser Triangulator: uses high-speed & high-efficiency non-contact laser probe to perform complex profile measurements.
- Laser Scanner: takes range measurements over the entire path (rather than measuring single point) for scanning of a region.
- > So, they can be used for **measurement of distance and/or surface topography** within certain measurement ranges.

More information: keyence.com







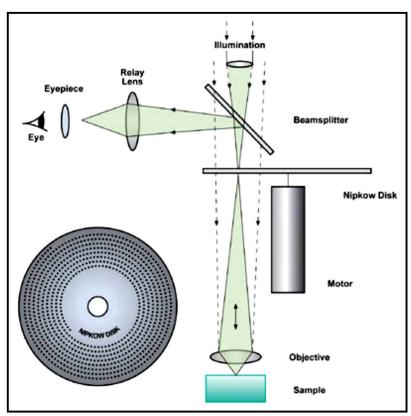




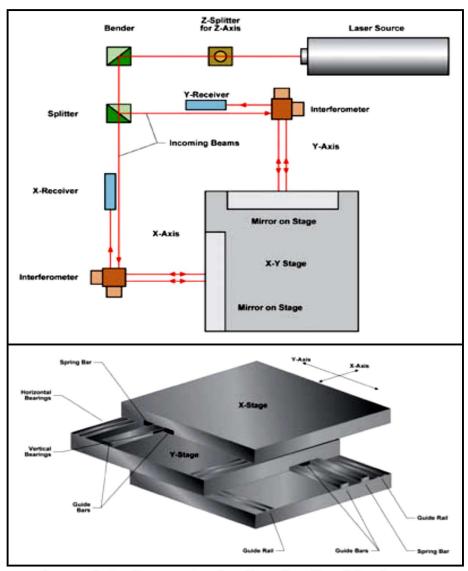


Laser Interferometers

- Provide advanced measurement systems for vision, positioning, movement.
- > Higher precision, accuracy, speed as compared to common optical interferometers.



Laser Interferometer for Enhanced Vision

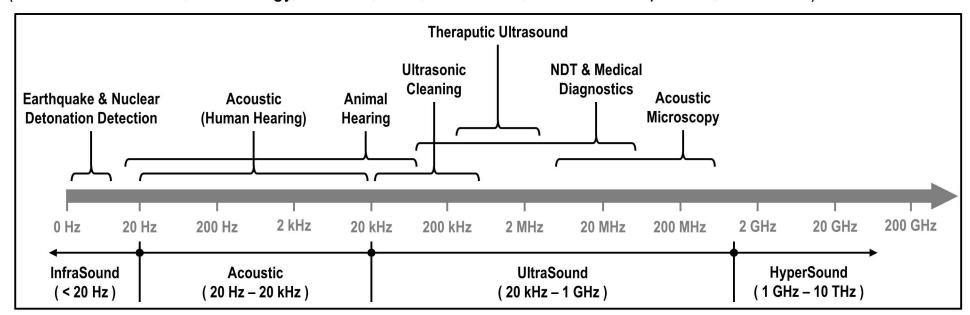


Laser Interferometer for Precise Positioning



Measurement using Sound

- > Sound is a sequence of waves of pressure propagating through a compressible media (air, water, solids, etc.)
- > During propagation, waves are **reflected**, **refracted** or **attenuated** by the medium.
- Sound waves are classified into specific ranges according to their frequencies:
 - ➤ Infrasound: has the frequency of less than 20 Hz (the limit of human hearing)
 - ➤ Acoustic: is the range of human hearing (the range of audible sound)
 - ➤ **Ultrasound:** has the frequency of greater than 20 kHz (not audible by human)
- From **metrology viewpoint**, sounds waves with certain frequencies & amplitudes are used in many applications (such as underwater, seismology, medical, NDT, infrasound, ultrasonic inspection, and so on).

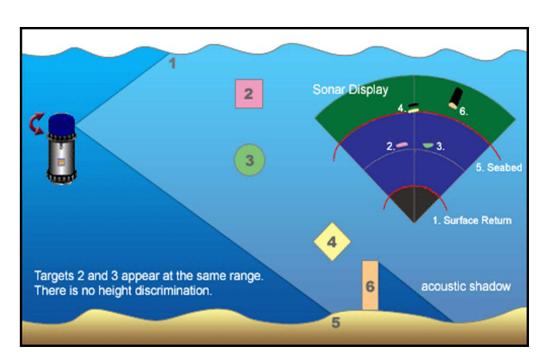


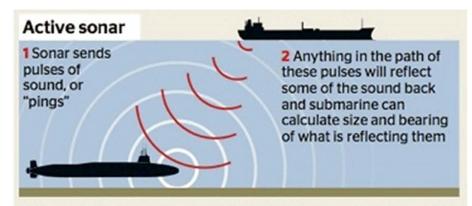




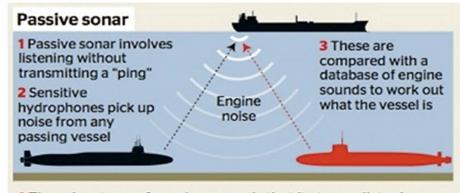
SONAR Measurement

- SONAR stands for "SOund NAvigation and Ranging"
- ➤ The technique using underwater sound propagation to navigate, communicate or detect the objects.
- > There are two SONAR systems:
 - ➤ Active SONAR: deploys & recevies its own signal
 - ➤ Passive SONAR: just listening any signal





The advantage of active sonar is that it gives a very clear picture of what surrounds the submarine using it. The disadvantage is that sending out a "ping" reveals the submarine's own location to anyone listening out for it



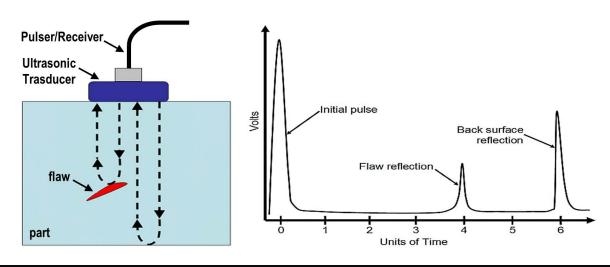
4 The advantage of passive sonar is that it stops a listening submarine giving its position away. The disadvantage is that many nuclear submarines are too quiet to be detected by passive sonar. This makes them invisible to one another, increasing the risk of collisions



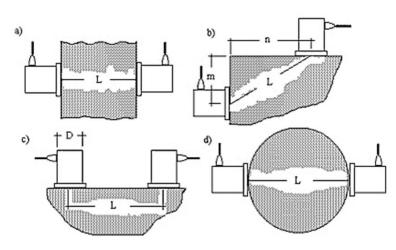


Ultrasonic Testing

- ➤ Uses high-frequency sound energy to conduct flaw detection, dimensional inspection, material characterization, and more.
- ➤ The testing setup consists of: a pulser/receiver, a transducer, a display software/device.
- ➤ Pulser/receiver produces high voltage electrical pulses. Driven by pulser, the transducer generates high-frequency ultrasonic energy, which propagates through the part in form of waves.
- ➢ If there is discontinuity (crack/flaw) in the wave path, some part of energy is reflected back from flaw surface. Voltage signals of reflecting energy reveals location & size of the flaw.







Typical schemes

- a) one-axis through testing b) angle testing
- c) one-surface testing d) curve surface testing

